

## UNITED STATES PATENT AND TRADEMARK OFFICE



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APPLICATION NO	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO	CONFIRMATION NO
09 500,288	02 08 2000	Shinichi Nagahama	NICHIA-00800	2385
	590 09 24 2002			N'ED
Nixon & Vanderhye, PC			EXAMINER	
1100 North Glebe Rd, 8th Floor Arlington, VA 22201-4714			LOUIE. WAI SING	
			ART UNIT	PAPER NUMBER
			2814	

DATE MAILED: 09 24 2002

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
Office Action Summary	09/500,288	NAGAHAMA ET AL.	
Office Action Summary	Examiner	Art Unit	
The MAILING DATE of this commun	Wai-Sing Louie	2814	
The MAILING DATE of this commun Period for Reply	ication appears on the cover sheet v	vitil the correspondence datases	
A SHORTENED STATUTORY PERIOD F THE MAILING DATE OF THIS COMMUNI  - Extensions of time may be available under the provisions after SIX (6) MONTHS from the mailing date of this comn  - If the period for reply specified above is less than thirty (3  - If NO period for reply is specified above the maximum st  - Failure to reply within the set or extended period for reply  - Any reply received by the Office later than three months a earned patent term adjustment See 37 CFR 1 704(b)	of 37 CFR 1 136(a) In no event, however may a nunication (a) days, a reply within the statutory minimum of the attutory period will apply and will expire SIX (6) MC and the statute cause the application to become	a reply be timely filed  iirty (30) days will be considered timely  INTHS from the mailing date of this communication  ABANDONED (35 U S C § 133)	
Status	lad on 22 July 2002		
1) Responsive to communication(s) fi	2b)⊠ This action is non-final.		
24/	<i>'</i> —	attors prosecution as to the merits is	
Since this application is in condition closed in accordance with the prac	tice under <i>Ex parte Quayle</i> , 1935 C	atters, prosecution as to the merits is C.D. 11, 453 O.G. 213.	
Disposition of Claims			
4)⊠ Claim(s) <u>9-16</u> is/are pending in the	application.		
4a) Of the above claim(s) is/a	re withdrawn from consideration.		
5) Claim(s) is/are allowed.	•		
6)⊠ Claim(s) <u>9-16</u> is/are rejected.			
7) Claim(s) is/are objected to.	,		
8) $\mathbb{Z}$ Claim(s) $\frac{78}{2}$ are subject to restri	ction and/or election requirement.		
Application Papers			
9) The specification is objected to by th		the Eveniner	
10) The drawing(s) filed on is/are			
	jection to the drawing(s) be held in about		
11) The proposed drawing correction file  If approved, corrected drawings are re		disapproved by the Examinor.	
12) The oath or declaration is objected to			
· —	by the Examiner.		
Priority under 35 U.S.C. §§ 119 and 120  13) △ Acknowledgment is made of a claim	n for foreign priority under 35 U.S.C	: 8 119(a)-(d) or (f)	
	Thor loreign priority arract oc o.c.e	3 1 10(0) (1) 0 (1)	
a) All b) Some * c) None of:	documents have been received.		
<ul><li>1.</li></ul>		Application No	
	of the priority documents have been		
application from the Inter * See the attached detailed Office action	national Bureau (PCT Rule 17.2(a) on for a list of the certified copies n	). ot received	
14) Acknowledgment is made of a claim	for domestic priority under 35 U.S.0	C. § 119(e) (to a provisional application)	
<ul> <li>a)  The translation of the foreign la</li> <li>15)  Acknowledgment is made of a claim</li> </ul>	nguage provisional application has for domestic priority under 35 U.S.	been received. C. §§ 120 and/or 121.	
Attachment(s)			
Notice of References Cited (PTO-892)     Notice of Draftsperson's Patent Drawing Review (     Information Disclosure Statement(s) (PTO-1449)	PTO-948) 5) Notice	of Informal Patent Application (PTO-152)	

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hong et al. (US 6,177,292) in view of Koide (JP 11-145516) and Kern et al. (US 6,194,742).

With regard to claim 9, Hong et al. disclose gallium nitride semiconductor diode (col. 4. line 3 to col. 11, line 64 and fig. 7) comprising:

- A GaN substrate 70 having a single-crystal GaN on its surface. Hong et al. do not disclose the single-crystal GaN layer 70 is formed through a lateral. However. Koide disclose a lateral growth method to form a GaN layer 3 on a sacrificial AlGaN layer. The GaN layer 3 would epitaxially grow in vertical as well as laterally direction (Koide [0001] to [0005] and fig.1). Koide teaches the lateral grow method would not generate cracks and dislocation within the GaN layer (Koide [0004]). Therefore, it would have been obvious to one with ordinary skill in the art to adopt Koide's lateral grow method for Hong's device. Doing so would avoid forming cracks in the GaN layer.
  - A device-forming layer 71 made of nitride semiconductor that are formed on the GaN substrate 70 (col. 10, lines 17-42 and fig 7), where the device-forming layer

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contacting the GaN substrate is made of Al<sub>a</sub>Ga<sub>1-a</sub>N (0<a<1). Hong et al. do not disclose the AlGaN layer has a coefficient of thermal expansion less than that of GaN substrate. However, Kern et al. disclose a LED having an AlGaN device-forming layer (interfacial layer 16). Kern et al. disclose the coefficient of thermal expansion of GaN and AlN (see col. 2, table 1). By estimation, the coefficient of thermal expansion of Al<sub>a</sub>Ga<sub>1-a</sub>N is about 4.45x10<sup>-6</sup>/K, when a=0.1. The coefficient of thermal expansion of AlGaN layer is, therefore, less than GaN substrate thereby providing compression strain on the AlGaN device-forming layer (col. 4. lines 29-32).

With regard to claims 10-16, please see the description of record.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Wai-Sing Louie whose telephone number is (703) 305-0474. The examiner can normally be reached on 7:30 AM to 4:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on (703) 306-2794. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

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